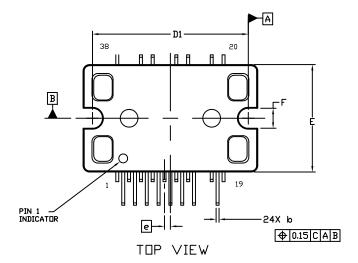
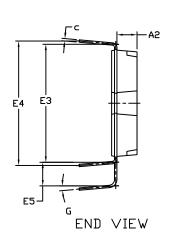


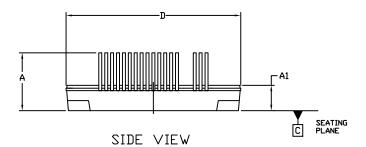
MODULE SPCM24 29.6x18.2 DIP S3

CASE MODBL ISSUE A

DATE 08 MAR 2016







NOTES:

- DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSION 6 APPLIES TO THE PLATED LEAD AND IS MEASURED BETWEEN 0.10 AND 0.25 FROM THE LEAD TIP.
- PACKAGE IS MISSING PINS: 15, 16, 21, 23, 24, 25, 27, 29, 30, 31, 33, 35, 36, AND 37.

| | MILLIMETERS | | |
|-----|-------------|-------|--|
| DIM | MIN. | MAX. | |
| Α | 9.30 | 10.30 | |
| A1 | 3.80 | 4.80 | |
| A2 | 2.90 | 3.90 | |
| b | 0.45 | 0.70 | |
| С | 0.35 | 0.60 | |
| D | 29.10 | 30.10 | |
| D1 | 26.30 | 26.50 | |
| D2 | 19.20 | 20.20 | |
| E | 17.70 | 18.70 | |
| E2 | 14.90 | 15.90 | |
| E3 | 19.50 | 20.50 | |
| E4 | 21.10 REF | | |
| E5 | 3.50 | 4.50 | |
| e | 1.00 BSC | | |
| F | 2.90 | 3.90 | |
| G | 4* | 6* | |

| | E2 |
|------------|-----|
| | |
| | н Ш |
| l D2 | |
| B□TT□M VIE | ΞW |

| DESCRIPTION | MODULE SPCM24 29.6X18.2 DIP S3 | | PAGE 1 OF 1 |
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